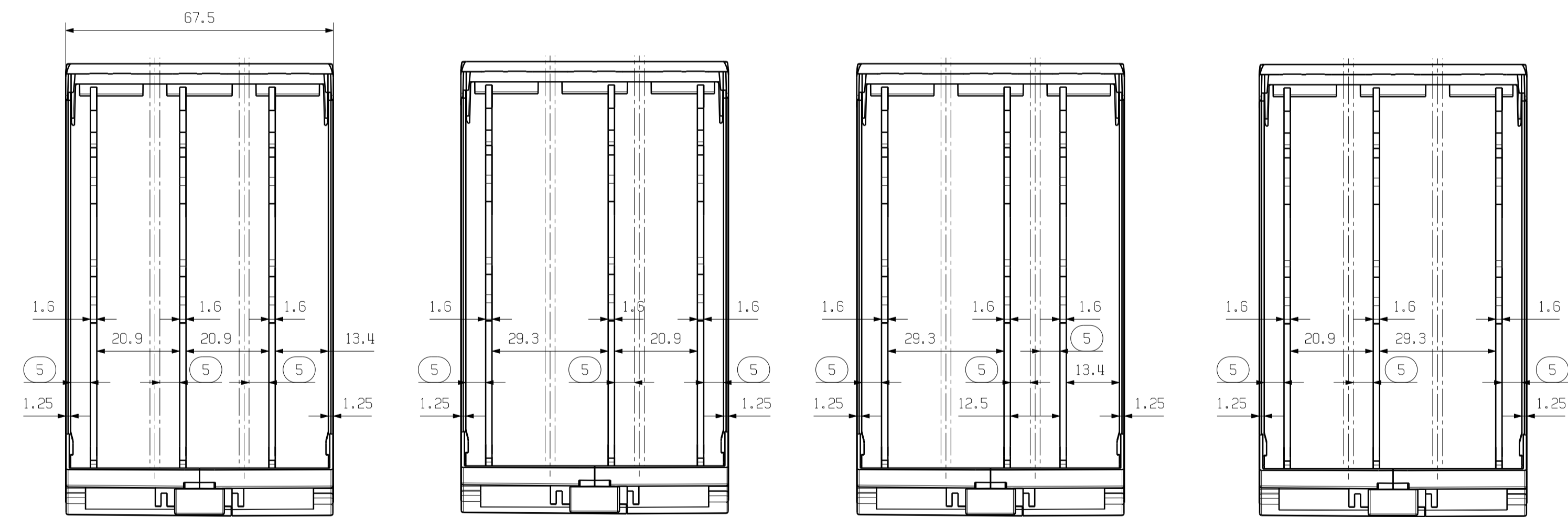
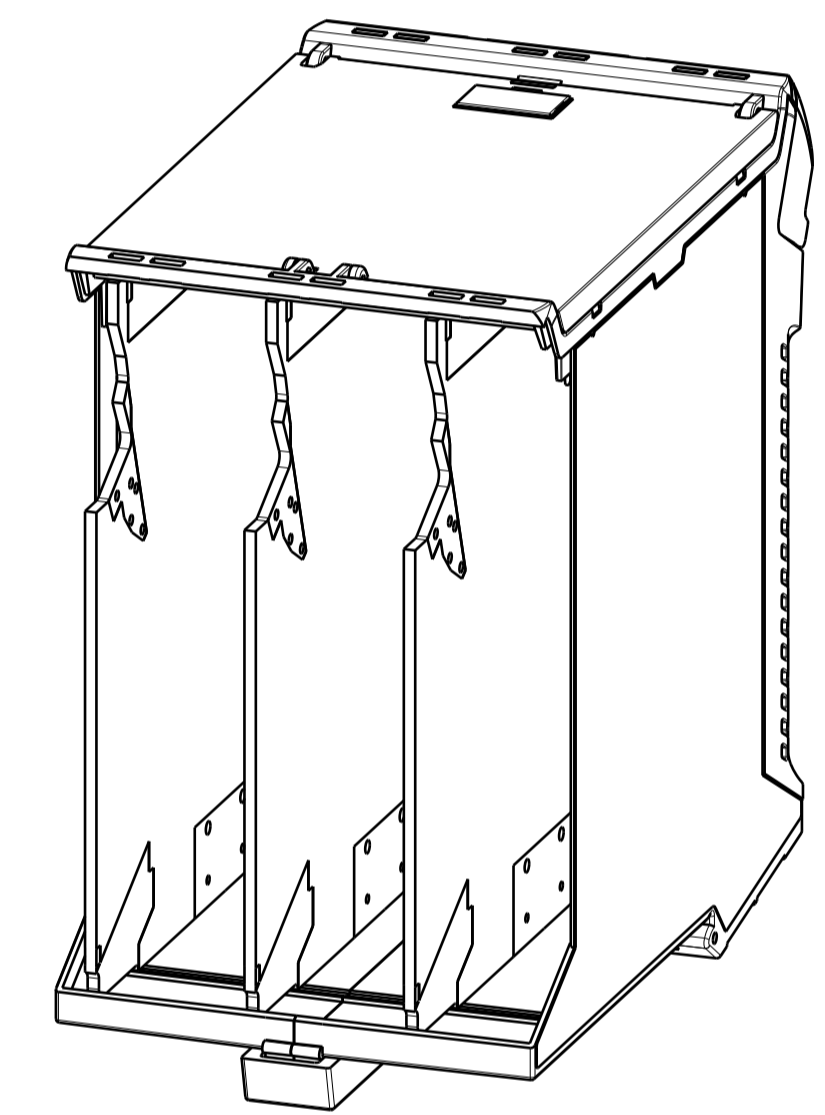
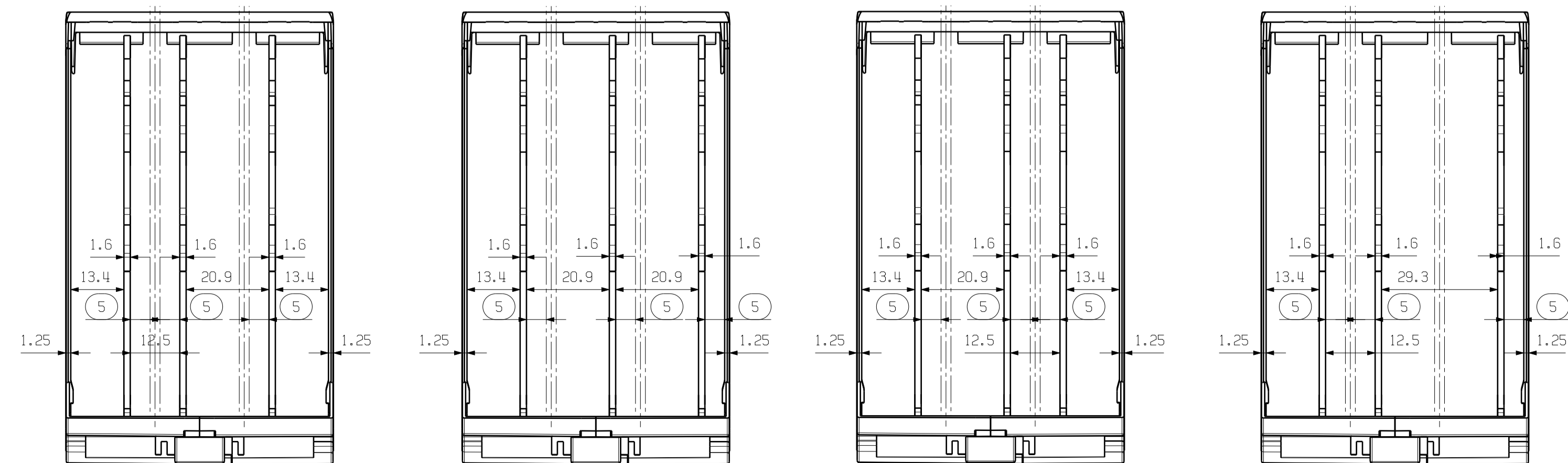



Abstand Gehäusewand zur LP: 2.3mm  
 Distance moulding wall to PCB: 2.3mm  
 Darstellung der Position der Stiftleisten siehe (Z.-Nr.): CH20M A OV PCB-SHL (70315)  
 Representation of the position of the pin headers see (d.no.):



Abstand Gehäusewand zur LP: 5.0mm  
 Distance moulding wall to PCB: 5.0mm  
 Darstellung der Position der Stiftleisten siehe (Z.-Nr.): CH20M A OV PCB-SHL (70315)  
 Representation of the position of the pin headers see (d.no.):



EC00004186	Prim PLM Part No.: 1159375	Prim ERP Part No.:
First Issue Date 28.06.2019	Max. nos. Modification	<b>Weidmüller</b>  <b>70144</b>
Drawn 25.11.2020 Responsible	Date 12.01.2021 Name Fischer, Klaus	Issue no. 1 Sheet 01 of 01 sheets
Scale: 1/1	Size: A1	Drawings Customer
		Product file: 5670.CH20...

LP-POSITION 67MM  
 LEITERPLATTEN-POSITION  
 PCB-POSITION

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